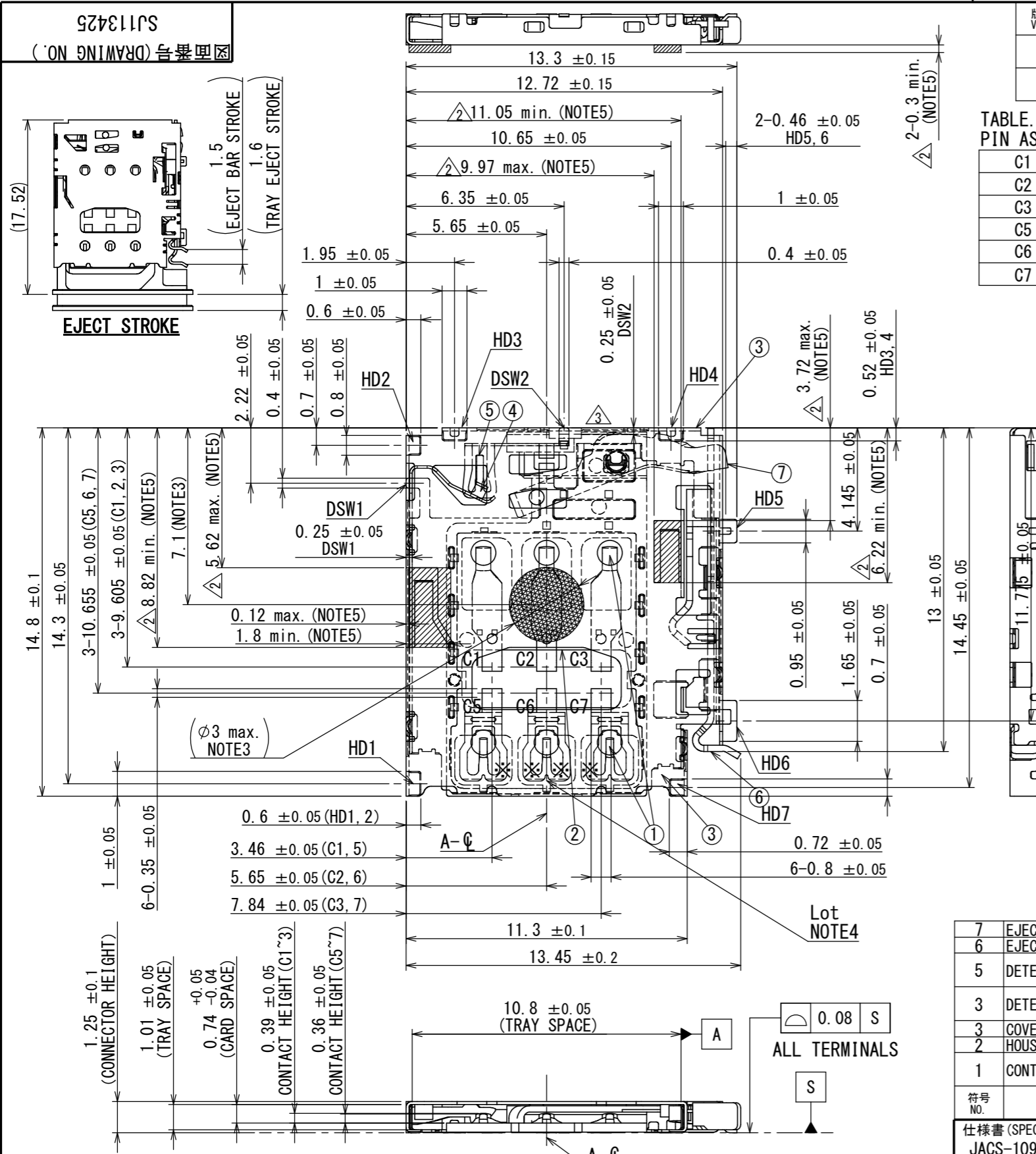


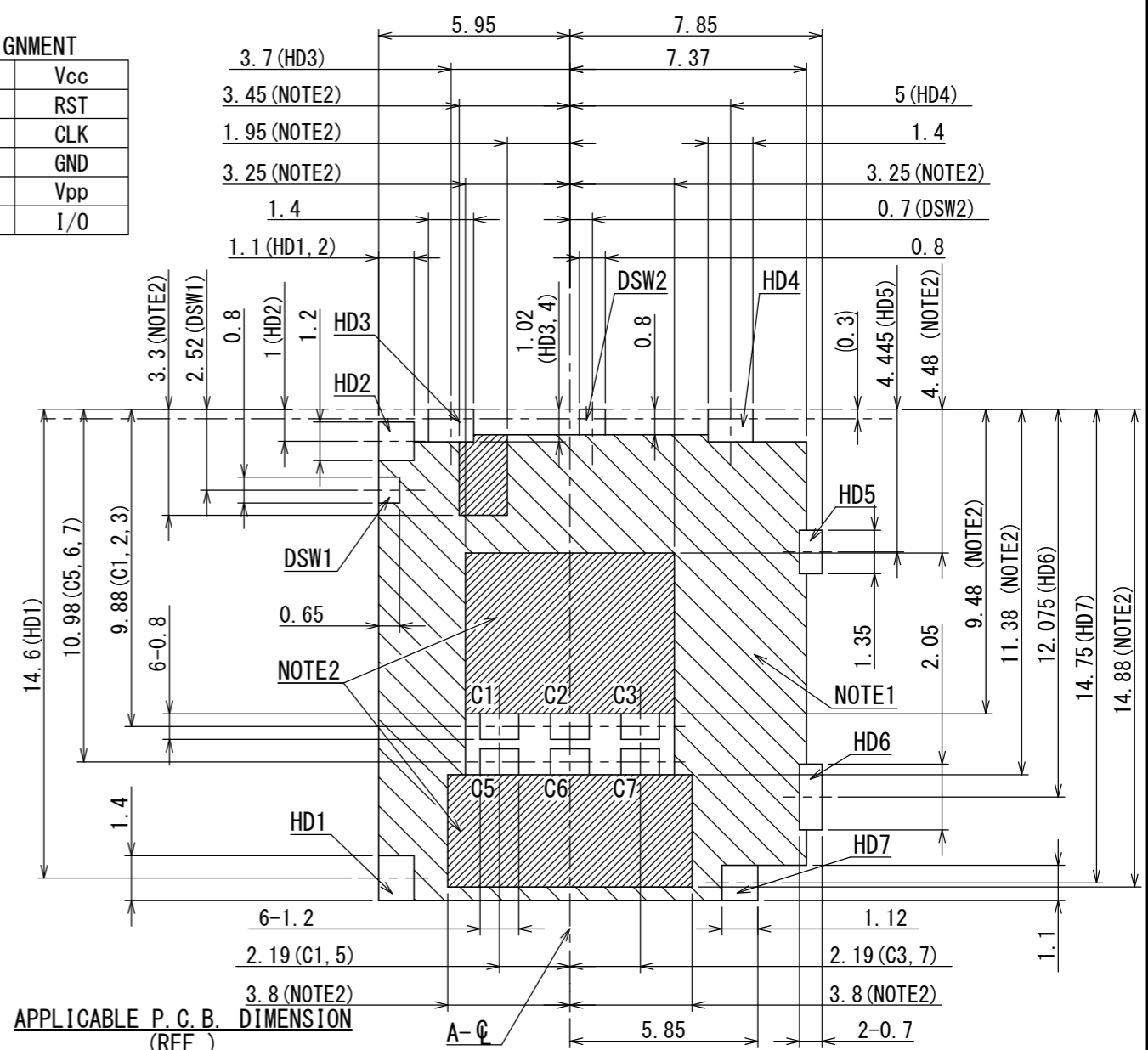
図面番号 (DRAWING NO.) SJ113425



版数 VER.	年月日 DATE	CN NO.	変更内容 DESCRIPTION	製図 DR.	担当 CHK.	査閲 APPD.	承認 APPD.
2	30/MAR/2016	016908	ADD NOTE5~8		K. KUME	-	M. SHIMADA
3	09/JAN/2020	032839	Changed form		K. KUME	-	M. SHIMADA

TABLE 1
PIN ASSIGNMENT

C1	Vcc
C2	RST
C3	CLK
C5	GND
C6	Vpp
C7	I/O



APPLICABLE P.C.B. DIMENSION (REF.)

符号 NO.	名称 DESCRIPTION	個数 QTY.	材料 MATERIAL	仕上 FINISH	図番 DWG NO.
7	EJECT LEVER	1	STAINLESS STEEL	-	
6	EJECT BAR	1	STAINLESS STEEL	-	
5	DETECTION SW2	1	COPPER ALLOY	CONTACT: Au (0.3~0.5 μm MIN) OVER Ni ((1~2 μm MIN)) TERMINAL: Au (0.03~0.07 μm MIN) OVER Ni (1~2 μm MIN)	
3	DETECTION SW1	1	COPPER ALLOY	CONTACT: Au (0.3~0.5 μm MIN) OVER Ni ((1~2 μm MIN)) TERMINAL: Au (0.03~0.07 μm MIN) OVER Ni (1~2 μm MIN)	
3	COVER FRAME	1	STAINLESS STEEL	TERMINAL: Au (0.03~0.07 μm MIN) OVER Ni (0.5~2 μm MIN)	
2	HOUSING	1	GLASS FILLED LCP		
1	CONTACT	1	COPPER ALLOY	CONTACT: Au (0.3~0.5 μm MIN) OVER Ni ((1~2 μm MIN)) TERMINAL: Au (0.03~0.07 μm MIN) OVER Ni (1~2 μm MIN)	

TABLE 2
CIRCUIT

	WITHOUT TRAY	TRAY MATED
DSW	④ - ⑤ ↓ GND	④ - ⑤ ↓ GND

NOTE1. ONLY GND PATTERN AND GND VIA HOLE IN ALLOWED IN THIS AREA.
NOTE2. NO PATERN, VIA HOLE IN THIS AREA.
NOTE3. VACUUM AREA.
NOTE4. LOT NUMBER (4-digit Y M D D)
Y: A. D. 2013-3
M: PRODUCTION MONTH Oct: 0 Nov: X Dec: Y
DD: PRODUCTION DAY
NOTE5. THERE IS NO APPLY THE LOAD ON THIS AREA BY THE CASE.
NOTE6. MOUNTING BEFORE THE OPERATION PROHIBITION.
NOTE7. RECOMMENDED OPEN APERTURE RATIO OF METAL MASK: 100% THICKNESS: ±0.1.
NOTE8. APPLICABLE SLIDE TRAY (SJ113757**) AND CARD (4FF).
NOTE9. HALOGEN FREE.

DCF-G-212H(12.08)

WISDOM承認 2020/01/09

仕様書 (SPECIFICATION) JACS-10953 J AHL-10953	第1版 (ORIGINAL DATE) 25/APR/2013	尺度 (SCALE) 5:1	シリーズ (SERIES) SF70	日本航空電子工業株式会社 JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.	図番 (DRAWING NO.) SJ113425	版数 (VER.) 3
一般公差 (GENERAL TOLERANCE) 寸法 (DIMENSION) × ±0.8 ×× ±0.4 ××× ±0.1 ×××× ±	角度 (ANGLES) ×° ± ×°×' ±	製造 DR. 担当 CHK. 査閲 APPD. 承認 APPD.	名称 (TITLE) SF70S006VBA	質量 (MASS)	図番 (DRAWING NO.) SJ113425	版数 (VER.) 3